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April 2015

## **FDC8601**

# N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100 V, 2.7 A, 109 m $\Omega$

#### **Features**

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)}$  = 109 m $\Omega$  at  $V_{GS}$  = 10 V,  $I_D$  = 2.7 A
- Max  $r_{DS(on)}$  = 176 m $\Omega$  at  $V_{GS}$  = 6 V,  $I_D$  = 2.1 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

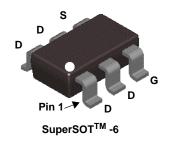


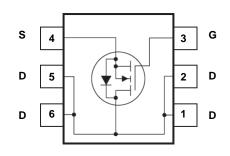
#### **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that incorporates Shielded Gate technology. This process has been optimized for  $r_{DS(on)}$ , switching performance and ruggedness.

#### **Applications**

- Load Switch
- Synchronous Rectifier
- Primary Switch





### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		100	V
$V_{GS}$	Gate to Source Voltage		±20	V
	Drain Current -Continuous	(Note 1a)	2.7	۸
ID	-Pulsed		12	_ A
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	13	mJ
D	Power Dissipation	(Note 1a)	1.6	W
$P_{D}$	Power Dissipation	(Note 1b)	0.8	VV
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case		30	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	78	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.861	FDC8601	SSOT-6	7 "	8 mm	3000 units

## **Electrical Characteristics** $T_J = 25 \, ^{\circ}\text{C}$ unless otherwise noted

**Parameter** 

_						
Off Chai	racteristics					
$BV_DSS$	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		70		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μА
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA

**Test Conditions** 

#### On Characteristics

Symbol

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.0	3.0	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		-8		mV/°C
		$V_{GS} = 10 \text{ V}, I_D = 2.7 \text{ A}$		86	109	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, I_D = 2.1 \text{ A}$		119	176	mΩ
25(5)		$V_{GS} = 10 \text{ V}, I_D = 2.7 \text{ A}, T_J = 125 ^{\circ}\text{C}$		144	183	
g <sub>FS</sub>	Forward Transconductance	$V_{DD} = 10 \text{ V}, I_D = 2.7 \text{ A}$		5		S

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 50 V V 0 V	155	210	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz	46	65	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1 1011 12	2.2	5	pF
$R_q$	Gate Resistance		0.9		Ω

#### **Switching Characteristics**

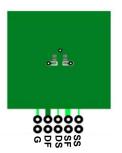
t <sub>d(on)</sub>	Turn-On Delay Time		V <sub>DD</sub> = 50 V, I <sub>D</sub> = 2.7 A,		4.5	10	ns
t <sub>r</sub>	Rise Time				1.3	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = 10 V, R <sub>GEN</sub> :	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		7.6	16	ns
t <sub>f</sub>	Fall Time				2	10	ns
0	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$			3	5	nC
$Q_{g(TOT)}$	Total Gate Charge	$V_{GS} = 0 V to 5 V$	V <sub>DD</sub> = 50 V		1.7	3	nC
$Q_{gs}$	Total Gate Charge		$I_D = 2.7 \text{ A}$		0.9		nC
$Q_{gd}$	Gate to Drain "Miller" Charge				0.8		nC

#### **Drain-Source Diode Characteristics**

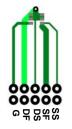
$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 2.7 \text{ A}$	(Note 2)	0.85	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	-I <sub>F</sub> = 2.7 A, di/dt = 100 A/μs		34	54	ns
Q <sub>rr</sub>	Reverse Recovery Charge			21	34	nC

#### NOTES

 $R_{0,C}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{0,C}$  is guaranteed by design while  $R_{0,C}$  is determined by the user's board design.



a. 78 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



b.175 °C/W when mounted on a minimum pad of 2 oz copper

Typ

Max Units

- 2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0 %.
- 3. Starting T  $_{J}$  = 25 °C, L = 3 mH, I  $_{AS}$  = 3 A, V  $_{DD}$  = 100 V, V  $_{GS}$  = 10 V.

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

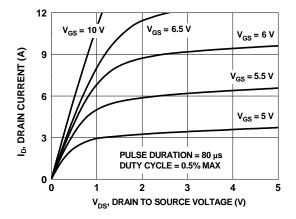


Figure 1. On-Region Characteristics

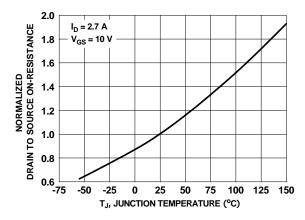


Figure 3. Normalized On-Resistance vs Junction Temperature

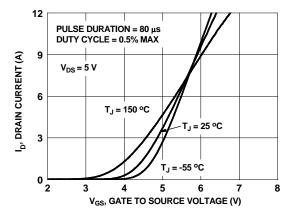


Figure 5. Transfer Characteristics

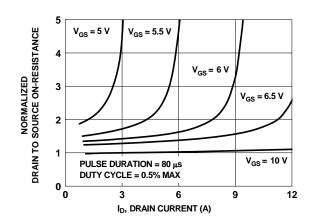


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

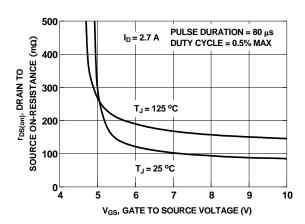


Figure 4. On-Resistance vs Gate to Source Voltage

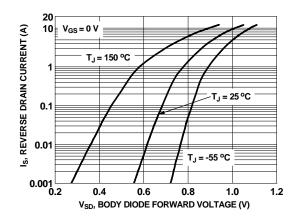


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

### **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

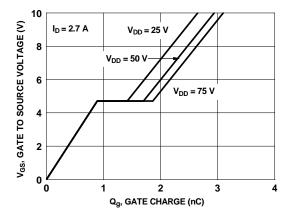


Figure 7. Gate Charge Characteristics

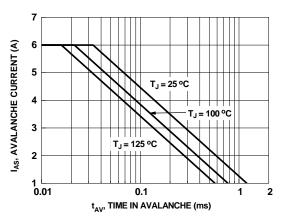


Figure 9. Unclamped Inductive Switching Capability

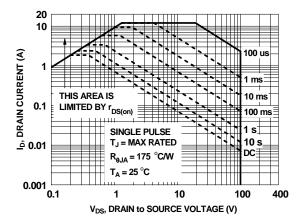


Figure 11. Forward Bias Safe Operating Area

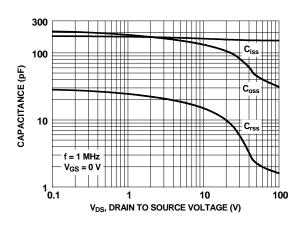


Figure 8. Capacitance vs Drain to Source Voltage

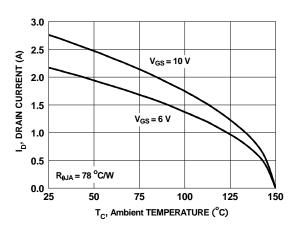


Figure 10. Maximum Continuous Drain Current vs Ambient Temperature

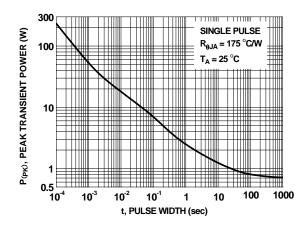


Figure 12. Single Pulse Maximum Power Dissipation

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

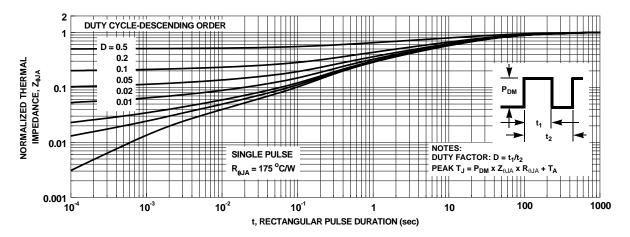
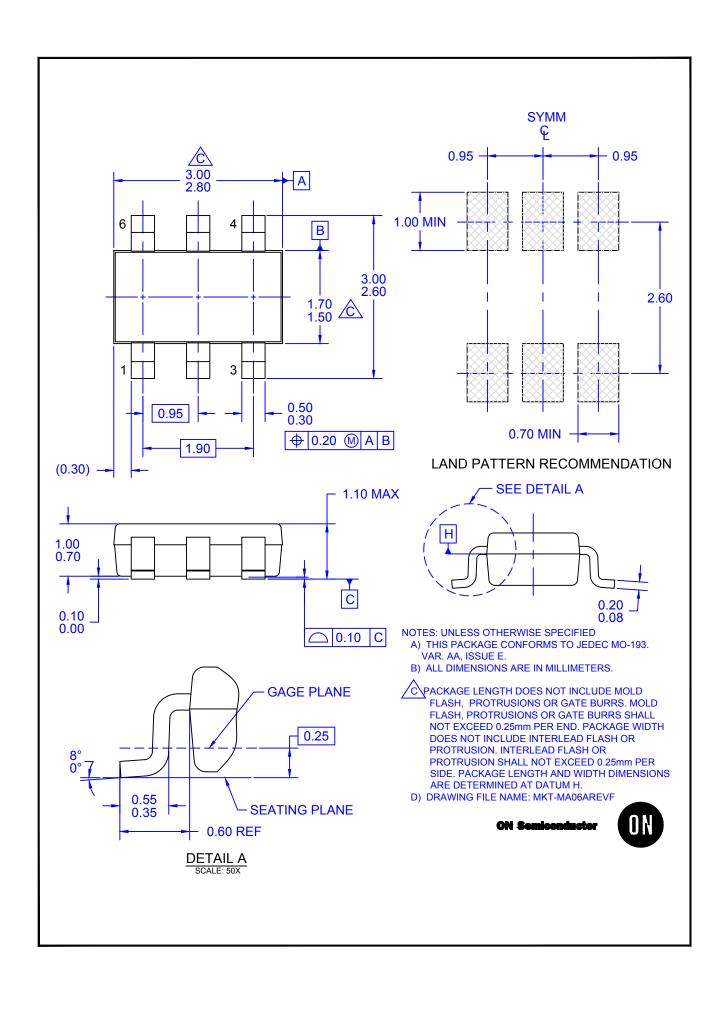


Figure 13. Juncton-to-Ambient Transient Thermal Response Curve



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